

Part Number: BAV99W-p-F, BAW56W-p-F Weight (mg): 6.23

Weight (mg):	(mg): 6.23 See Data			neet				
(HF Date Code Limited. See Data Sheet)								
Element	Material Group	Materials	CAS (if applicable)	Average mass homogeneous Materal(%)		Mass (mg)	ppm Homogeneous Material	ppm overall
Chip	Silicon w/Metal	Doped Silicon*	7440-21-3	100.00%	2.17	0.14	1000000	21703
Leadframe		Fe	7439-89-6	57.65%	26.74	1.67	576500	154175
		Ni	7440-02-0	41.00%			410000	109647
	Alloy 42	Mn	7439-96-5	0.60%			6000	1605
	AllOy 42	Cr(not Cr 6+)	7440-47-3	0.10%			1000	267
		Со	7440-48-4	0.50%			5000	1337
		Si	7440-21-3	0.15%			1500	401
Leadframe Plating	Silver	Silver	7440-22-4	100.00%	1.01	0.06	1000000	10097
Bond Wire	Copper Wire	Cu	7440-50-8	100.00%	0.18	0.01	1000000	1846
Encapsulation		SiO2	60676-86-0	87.30%	66.27	4.13	873000	578515
		Epoxy Resin	29690-82-2	5.00%			50000	33134
	CEL-1702HF-9	Phenol Resin	26834-02-6	5.00%			50000	33134
		Aromatic poly-phosphate		2.50%			25000	16567
		С	1333-86-4	0.20%			2000	1325
Lead Plating Finish	Matte Tin	Tin	7440-31-5	100.00%	3.62	0.23	1000000	36246
				Total	100.00	6.23		100000

p = Package Indicator

+10% Tolerance

This data is based on information provided by our suppliers. We believe it to be correct but do not routinely validate it by measurement. It is for guidance only and Diodes Inc. does not guarantee its absolute accuracy or completeness

* The Silicon Chip is doped at atomic levels with trace amounts of elements that may include Phosphorus, Boron, Arsenic, and other elements. Metalization may include Titanium, Nickel, Aluminum, Silver or Gold These substances are not reported where their concentration is less than the minimum reportable level per the guidelines specified in the Tables of EIA JIG-101, Material Composition Declaration for Electronic Products.

This product or product family does not contain any of the following substances except as CURRENTLY exempted by ELV II and RoHS and reported above:

Asbestos Antimony Compounds Azo compounds Cadmium and cadmium compounds Certain Shortchain Chlorinated Paraffins Chlorinated organic compounds Halogens Hexavalent chromium compounds Lead and lead compounds Mercury and mercury compounds Organic tin compounds Ozone Depleting Substances - Class I (CFCs, HBFCs, etc.) Ozone Depleting Substances - Class II (HCFCs) Perfluorooctane Sulphonate (PFOS) or related compounds Polybrominated biphenyls (PBB) and Polybrominated diphenyl ethers (PBDE) including DecaBDE Polychlorinated Biphenyls (PCBs) Polychlorinated Naphthalenes (> 3 chlorine atoms) Radioactive Substances Tributyl Tin (TBT) and Triphenyl Tin (TPT) Tributyl Tin Oxide (TBTO)